



YEA SHIN TECHNOLOGY CO., LTD

YS03N20L

## N-Channel Enhancement MOSFET

VDS= 200V, ID= 3A



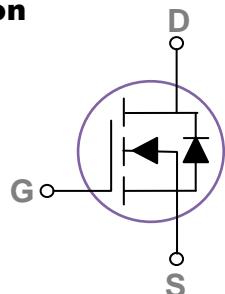
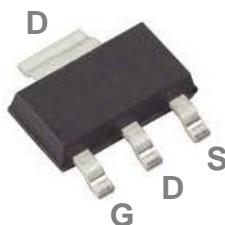
### Features

- Improved dv/dt capability
- Fast switching
- Green Device Available

### Applications

- High efficient switched mode power supplies
- TV Power
- Adapter/charger
- Server Power
- Networking

### SOT-223 Pin Configuration



### Absolute Maximum Rating Tc=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	200	V
V <sub>GS</sub>	Gate-Source Voltage	±30	V
I <sub>D</sub>	Drain Current – Continuous (Tc=25°C)	3	A
	Drain Current – Continuous (Tc=100°C)	1.9	A
I <sub>DM</sub>	Drain Current – Pulsed <sup>1</sup>	12	A
P <sub>D</sub>	Power Dissipation (Tc=25°C)	1.78	W
	Power Dissipation – Derate above 25°C	0.014	W/°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	°C

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction to ambient	---	70	°C / W
R <sub>θJC</sub>	Thermal Resistance Junction to Case	---	20	°C / W

# DEVICE CHARACTERISTICS

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Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

### Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=250\mu\text{A}$	200	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$\text{BV}_{\text{DSS}}$ Temperature Coefficient	Reference to $25^\circ\text{C}$ , $I_{\text{D}}=1\text{mA}$	---	0.5	---	$\text{V}/^\circ\text{C}$
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=200\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$V_{\text{DS}}=160\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	10	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 30\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA

### On Characteristics

$R_{\text{DS(ON)}}$	Static Drain-source On-Resistance <sup>2</sup>	$V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=2\text{A}$	---	0.7	0.85	$\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_{\text{D}}=250\mu\text{A}$	3	4	5	V
$\Delta V_{\text{GS(th)}}$	$V_{\text{GS(th)}}$ Temperature Coefficient		---	-8	---	$\text{mV}/^\circ\text{C}$
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=10\text{V}$ , $I_{\text{D}}=2\text{A}$	---	3.6	---	S

### Dynamic and Switching Characteristics

$Q_g$	Total Gate Charge <sup>2,3</sup>	$V_{\text{DS}}=160\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=1\text{A}$	---	4.8	9	nC
$Q_{gs}$	Gate-Source Charge <sup>2,3</sup>		---	2	4	
$Q_{gd}$	Gate-Drain Charge <sup>2,3</sup>		---	0.8	2	
$T_{d(on)}$	Turn-On Delay Time <sup>2,3</sup>	$V_{\text{DD}}=100\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_{\text{G}}=25\Omega$ , $I_{\text{D}}=1\text{A}$	---	10	20	ns
$T_r$	Rise Time <sup>2,3</sup>		---	35	70	
$T_{d(off)}$	Turn-On Delay Time <sup>2,3</sup>		---	10	20	
$T_f$	Fall Time <sup>2,3</sup>		---	28	56	
$C_{iss}$	Input Capacitance	$V_{\text{DS}}=25\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	266	500	pF
$C_{oss}$	Output Capacitance		---	160	300	
$C_{rss}$	Reverse Transfer Capacitance		---	55	110	
$R_g$	Gate Resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $f=1\text{MHz}$	---	1.5	3	$\Omega$

### Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	3	A
$I_{sM}$	Pulsed Source Current <sup>2</sup>		---	---	6	A
$V_{SD}$	Diode Forward Voltage <sup>2</sup>	$V_{\text{GS}}=0\text{V}$ , $I_{\text{s}}=1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$  , duty cycle  $\leq 2\%$ .
3. Essentially independent of operating temperature.

# DEVICE CHARACTERISTICS

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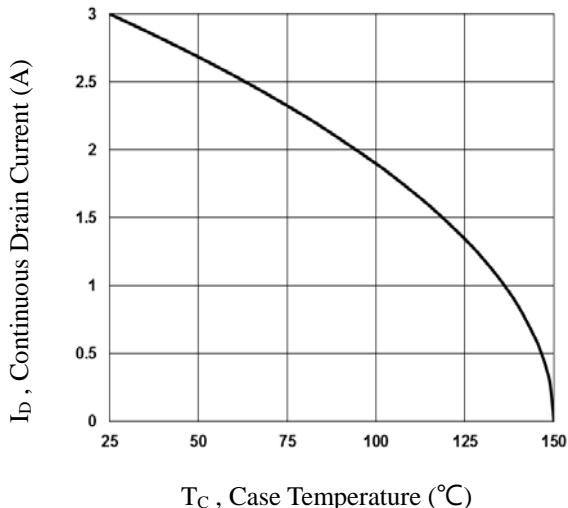


Fig.1 Continuous Drain Current vs.  $T_c$

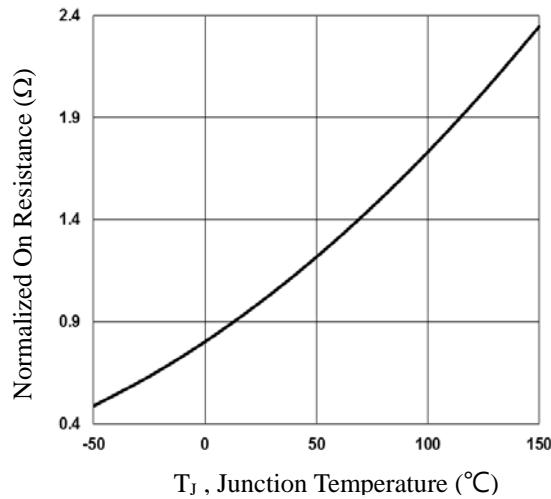


Fig.2 Normalized RDS(on) vs.  $T_j$

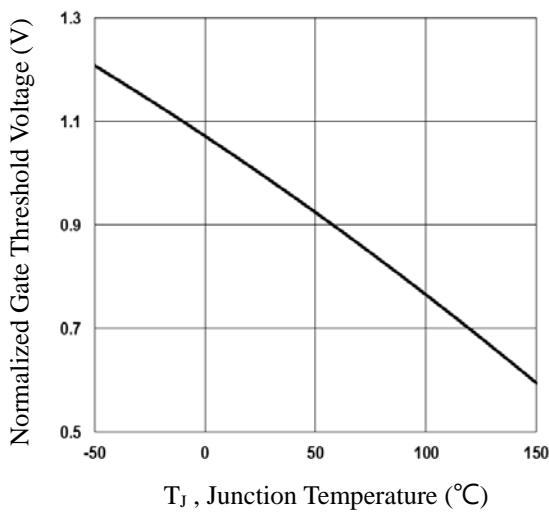


Fig.3 Normalized  $V_{th}$  vs.  $T_j$

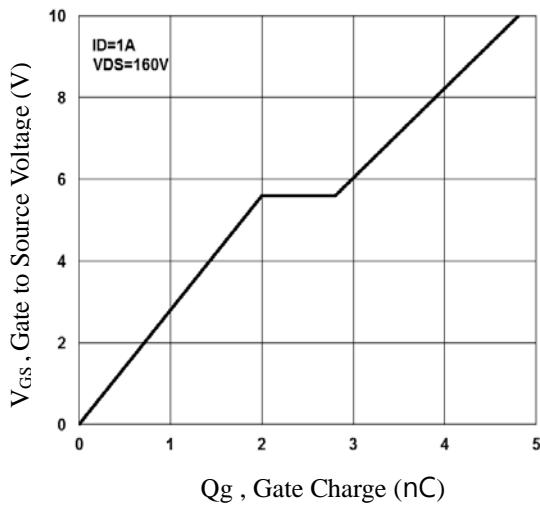


Fig.4 Gate Charge Waveform

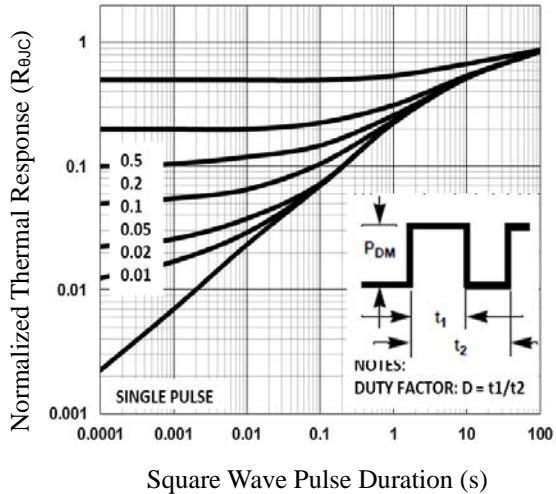


Fig.5 Normalized Transient Impedance

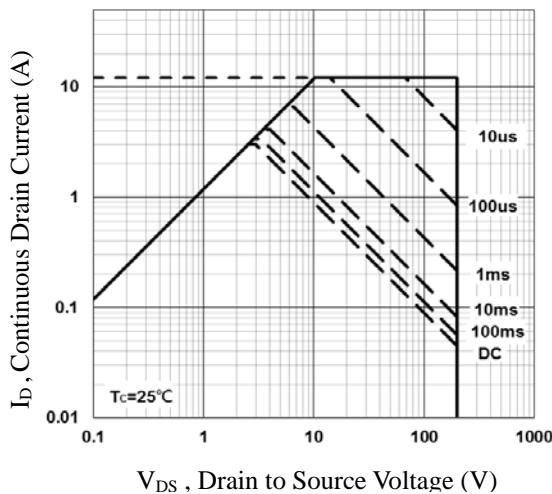
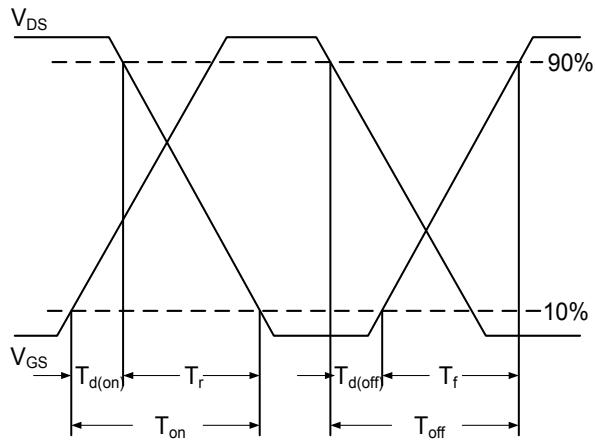


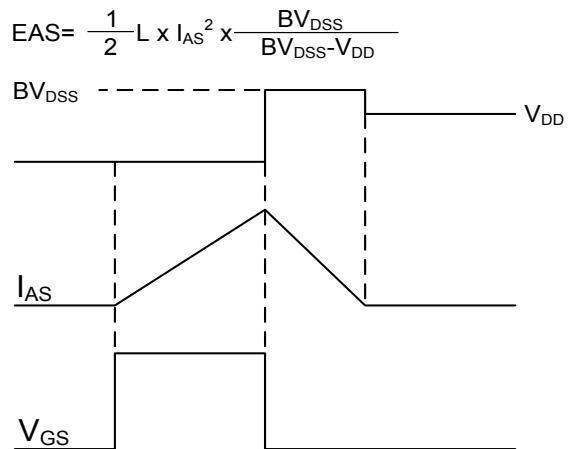
Fig.6 Maximum Safe Operation Area

# DEVICE CHARACTERISTICS

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**Fig.7** Switching Time Waveform

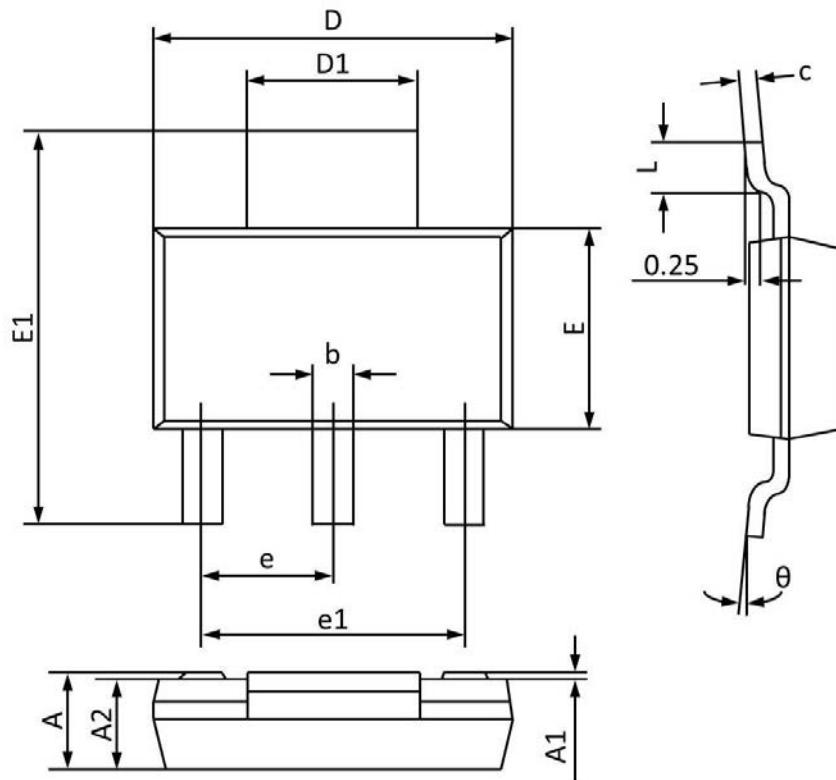


**Fig.8** EAS Waveform

# PACKAGE OUTLINE & DIMENSIONS

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## SOT-223 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.520	1.800	0.060	0.071
A1	0.000	0.100	0.000	0.004
A2	1.500	1.700	0.059	0.067
b	0.660	0.820	0.026	0.032
c	0.250	0.350	0.010	0.014
D	6.200	6.400	0.244	0.252
D1	2.900	3.100	0.114	0.122
E	3.300	3.700	0.130	0.146
E1	6.830	7.070	0.269	0.278
e	2.300 (BSC)		0.091 (BSC)	
e1	4.500	4.700	0.177	0.185
L	0.900	1.150	0.035	0.045
θ	0°	10°	0°	10°